

HXPA7081G Power Amplifier

1. Description

ID	Items	Specifications
1-1	Type	Power Amplifier
1-2	Frequency Range	4GHz ~ 10GHz
1-3	Gain	≥50dB
1-4	Gain Flatness	≤±2.0dB
1-5	Saturated Output Power(Psat)	≥43dBm
1-6	Output 1dB Compression Point(P1dB)	/
1-7	Input VSWR	≤2.0
1-8	Isolation S12	≥70dB
1-9	Spurious	≤-60dBc
1-10	Harmonics	-15dBc Typical
1-11	Noise Figure	≤4.0dB
1-12	Impedance	50Ω
1-13	Input/Output Connectors	SMA-F
1-14	Control Connector	DB9-Male
1-15	DC Power Supply	+28V/≤3.5A
1-16	Efficiency@Psat	25% Typical

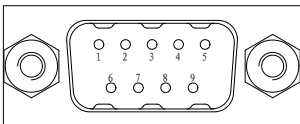
2. Absolute Maximum Ratings

ID	Parameter	Rating
2-1	Operating Voltage	+28V ~ +30V
2-2	RF Input Power	≤5dBm
2-3	Include voltage protection, current protection and temperature protection	

3. Environmental Specifications

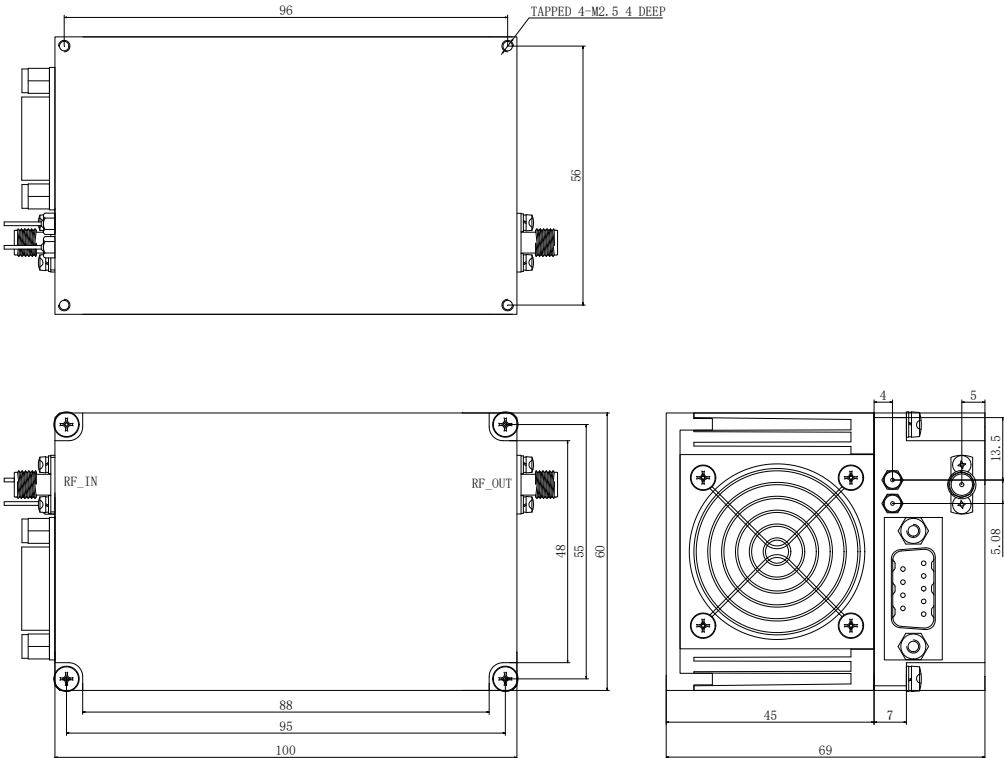
ID	Items	Specifications
3-1	Application Environment	CW/PL
3-2	Operational Temperature	-40°C ~ +70°C
3-3	Storage Temperature	-55°C ~ +85°C

4. Interface

ID	Items	Specifications
4-1	Control Connector	DB9-Male
		

4-2	NO	Specifications
	1,2,3,4	28V/DC
	5,6,7,8	GND
	9	TTL(0V=OFF/3.3V ~ 5V=ON) (TTL≤1us)

5. Outline Drawing

ID	Items	Specifications
5-1	Outline Drawing	Unit: mm
Tolerances:±0.5mm		
 The technical drawing consists of three views of the antenna module: Top View: Shows a rectangular module with overall dimensions of 96 mm (width) and 56 mm (height). It features four mounting holes at the corners, labeled "TAPPED 4-M2.5 4 DEEP". Side View: Shows the profile of the module with a total height of 60 mm. It includes RF connectors labeled "RF_IN" and "RF_OUT", and internal dimensions of 48 mm, 55 mm, and 88 mm. Front View: Shows the circular antenna element with a diameter of 45 mm. The mounting bracket has a width of 69 mm and a height of 13.5 mm. Other dimensions include 7 mm, 5.08 mm, and 4 mm.		
5-2	Material	Aluminum
5-3	Finish	Aluminum conductive coating
5-4	Weight	160g

6. Attention

6-1	Avoid damage amplifier, should be take the ESD protection during use .
6-2	Avoid using amplifier in extreme temperature, humidity, or corrosive environments.
6-3	Good grounding can reduce EMI and RFI.
6-4	Adding an isolator to the RF_OUT port can avoid damage amplifier by power reflection.
6-5	Ensure proper heat sinking of the power amplifier to preclude damage caused by excessive temperature rise during prolonged operation.
6-6	All specifications are subject to change without notice at any time.